## Notice for TAIYO YUDEN products

Please read this notice before using the TAIYO YUDEN products.

### !\ REMINDERS

Product information in this catalog is as of October 2015. All of the contents specified herein are subject to change without notice due to technical improvements, etc. Therefore, please check for the latest information carefully before practical application or usage of the Products.

Please note that TAIYO YUDEN CO., LTD. shall not be responsible for any defects in products or equipment incorporating such products, which are caused under the conditions other than those specified in this catalog or individual specification.

- Please contact TAIYO YUDEN CO., LTD. for further details of product specifications as the individual specification is available.
- Please conduct validation and verification of products in actual condition of mounting and operating environment before commercial shipment of the equipment.
- All electronic components listed in this catalogue are intended for use in general electronic equipment such as AV/OA equipment, home electrical appliances, office equipment, information-communication equipment, general medical equipment, industrial equipment, and automotive applications.
  Please be sure to contact TAIYO YUDEN CO., LTD. for further information before using the components for any equipment which might have a negative impact directly on human life, such as specially controlled medical equip-

ment, transportation equipment (automotive powertrain/train/ship control systems, etc.) and traffic signal system.

Please do not incorporate the components into any equipment requiring a high degree of safety and reliability, such as aerospace equipment, avionics, nuclear control equipment, submarine system, and military equipment.

For use in high safety and reliability-required devices/circuits of general electronic equipment, thorough safety evaluation prior to use is strongly recommended, and a protective circuit should be designed and installed as necessary.

- The contents of this catalog are applicable to the products which are purchased from our sales offices or distributors (so called "TAIYO YUDEN's official sales channel").

  It is only applicable to the products purchased from any of TAIYO YUDEN's official sales channel.
- Please note that TAIYO YUDEN CO., LTD. shall have no responsibility for any controversies or disputes that may occur in connection with a third party's intellectual property rights and other related rights arising from your usage of products in this catalog. TAIYO YUDEN CO., LTD. grants no license for such rights.
- Caution for export

Certain items in this catalog may require specific procedures for export according to "Foreign Exchange and Foreign Trade Control Law" of Japan, "U.S. Export Administration Regulations", and other applicable regulations. Should you have any question or inquiry on this matter, please contact our sales staff.

## **WIRE-WOUND CHIP INDUCTORS (LB SERIES)**





■PART NUMBER

\*Operating Temp. : -40~105°C (Including self-generated heat)

△=Blank space



①Series name	
Code	Series name

2 Characteristics	s
Code	Characteristic
ΔΔ	Standard
ΔC	High current
ΔR	Low Rdc

③Dimensions (L×W)				
Type (inch)	Dimensions (L×W)[mm]			
2012 (0805)	2.0 × 1.25			
2016 (0806)	2.0 × 1.6			
2518(1007)	2.5 × 1.8			
3218 (1207)	3.2 × 1.8			
3225(1210)	3.2 × 2.5			
	Type (inch)  2012 (0805)  2016 (0806)  2518 (1007)  3218 (1207)			

Code	Packaging
Т	Taping

### **⑤**Nominal inductance

Code (example)	Nominal inductance[ $\mu$ H]
1R0	1.0
100	10
101	100

\*R=Decimal point

### **6**Inductance tolerance

Code	Inductance tolerance
K	±10%
М	±20%

### 7Special code

<u> </u>	
Code	Special code
Δ	Standard
R	Low Rdc type

### 8 Internal code

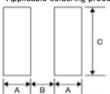
Code	Internal code				
V	Inductor for Industrial and Automotive				

### ■STANDARD EXTERNAL DIMENSIONS / STANDARD QUANTITY

Recommended Land Patterns

Surface Mounting

- •Mounting and soldering conditions should be checked beforehand.
- •Applicable soldering process to these products is reflow soldering only.



Type	Α	В	С
2012	0.60	1.0	1.45
2016	0.60	1.0	1.8
2518	0.60	1.5	2.0
3218	0.85	1.7	2.0
3225	0.85	1.7	2.7

Unit:mm

Type	1	W	Т	е	Standard quantity [pcs]	
Туре	L				Paper tape	Embossed tape
LB 2012 LB C2012 LB R2012	2.0±0.2 (0.079±0.008)	1.25±0.2 (0.049±0.008)	1.25±0.2 (0.049±0.008)	0.5±0.2 (0.020±0.008)	_	3000
LB 2016 LB C2016	2.0±0.2 (0.079±0.008)	1.6±0.2 (0.063±0.008)	1.6±0.2 (0.063±0.008)	0.5±0.2 (0.020±0.008)	_	2000
LB 2518 LB C2518 LB R2518	2.5±0.2 (0.098±0.008)	1.8±0.2 (0.071±0.008)	1.8±0.2 (0.071±0.008)	0.5±0.2 (0.020±0.008)	_	2000
LB 3218	3.2±0.2 (0.128±0.008)	1.8±0.2 (0.071±0.008)	$1.8 \pm 0.2$ (0.071 $\pm 0.008$ )	0.6±0.2 (0.024±0.008)	_	2000
LB C3225	3.2±0.2 (0.128±0.008)	2.5±0.2 (0.098±0.008)	2.5±0.2 (0.098±0.008)	0.6±0.3 (0.024±0.012)	_	1000

Unit:mm(inch)

<sup>▶</sup> This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our specification. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our Web site (http://www.ty-top.com/) .

• All the Wire-wound Chip Inductors of Catalog Lineup are Compliance RoHS.

#### Note)

- · Information about usage environment or condition is necessary depending on the application and circuit condition. Please contact TAIYO YUDEN sales channels.
- \*2: Industrial products and Medical products

Please consult with TAIYO YUDEN's official sales channel for the details of the product specification, etc.,

and please review and approve TAIYO YUDEN's product specification before ordering.

Please be sure to contact us for further information before using the components for Automotive equipment.

### **2012** (0805) type

Part number	Nominal inductance [ μ H]	Inductance tolerance	Self-resonant frequency [MHz] (min.)	DC Resistance [Ω](±30%)	Rated current [mA] (max.)	Measuring frequency [MHz]	Note
LB 2012T1R0M V	1.0	±20%	100	0.15	405	7.96	*2
LB 2012T2R2M V	2.2	±20%	80	0.23	260	7.96	*2
LB 2012T3R3M V	3.3	±20%	55	0.30	235	7.96	*2
LB 2012T4R7M V	4.7	±20%	45	0.40	190	7.96	*2
LB 2012T6R8M V	6.8	±20%	38	0.47	135	7.96	*2
LB 2012T100[] V	10	±10%, ±20%	32	0.70	120	2.52	*2
LB 2012T100[RV	10	±10%, ±20%	32	0.50	120	2.52	*2
LB 2012T150[] V	15	±10%, ±20%	28	1.3	100	2.52	*2
LB 2012T220[] V	22	±10%, ±20%	16	1.7	80	2.52	*2
LB 2012T470[] V	47	±10%, ±20%	11	3.7	60	2.52	*2
LB 2012T680[] V	68	±10%, ±20%	10	6.0	50	2.52	*2
LB 2012T101[] V	100	±10%, ±20%	8	7.0	45	0.796	*2

Part number	Nominal inductance [ μ H]	Inductance tolerance	Self-resonant frequency [MHz] (min.)	DC Resistance [Ω](±30%)	Rated current [mA] (max.)	Measuring frequency [MHz]	Note
LB C2012T1R0M V	1.0	±20%	100	0.19	620	7.96	*2
LB C2012T2R2M V	2.2	±20%	70	0.33	430	7.96	*2
LB C2012T4R7M V	4.7	±20%	45	0.50	295	7.96	*2
LB C2012T100□ V	10	±10%, ±20%	40	1.2	200	2.52	*2
LB C2012T220  V	22	±10%, ±20%	16	3.7	130	2.52	*2
LB C2012T470  V	47	±10%, ±20%	11	5.8	90	2.52	*2

Part number	Nominal inductance	Inductance tolerance	Self-resonant frequency [MHz] (min.)	DC Resistance [Ω](±30%)	Rated current [mA] (max.)	Measuring frequency [MHz]	Note
LB R2012T1R0M V	1.0	±20%	100	0.07	400	7.96	*2
LB R2012T2R2M V	2.2	±20%	80	0.13	260	7.96	*2
LB R2012T4R7M V	4.7	±20%	45	0.24	200	7.96	*2
LB R2012T100[] V	10	±10%, ±20%	32	0.36	150	2.52	*2
LB R2012T220[] V	22	±10%, ±20%	16	1.0	100	2.52	*2
LB R2012T470□ V	47	±10%, ±20%	11	1.7	75	2.52	*2
LB R2012T101[] V	100	±10%, ±20%	8	4.0	50	0.796	*2

### **2016** (0806) type

Part number	Nominal inductance [ μ H]	Inductance tolerance	Self-resonant frequency [MHz] (min.)	DC Resistance [Ω](±30%)	Rated current [mA] (max.)	Measuring frequency [MHz]	Note
LB 2016T1R0M V	1.0	±20%	100	0.09	490	7.96	*2
LB 2016T1R5M V	1.5	±20%	80	0.11	380	7.96	*2
LB 2016T2R2M V	2.2	±20%	70	0.13	375	7.96	*2
LB 2016T3R3M V	3.3	±20%	55	0.20	285	7.96	*2
LB 2016T4R7M V	4.7	±20%	45	0.25	225	7.96	*2
LB 2016T6R8M V	6.8	±20%	38	0.35	200	7.96	*2
LB 2016T100[] V	10	±10%, ±20%	32	0.50	155	2.52	*2
LB 2016T150[] V	15	±10%, ±20%	28	0.70	130	2.52	*2
LB 2016T220[] V	22	±10%, ±20%	16	1.0	105	2.52	*2
LB 2016T330[] V	33	±10%, ±20%	14	1.7	85	2.52	*2
LB 2016T470[] V	47	±10%, ±20%	11	2.4	70	2.52	*2
LB 2016T680[] V	68	±10%, ±20%	10	3.0	55	2.52	*2
LB 2016T101[] V	100	±10%, ±20%	8	4.5	40	0.796	*2

Part number	Nominal inductance [ $\mu$ H]	Inductance tolerance	Self-resonant frequency [MHz] (min.)	DC Resistance [Ω](±30%)	Rated current [mA] (max.)	Measuring frequency [MHz]	Note
LB C2016T1R0M V	1.0	±20%	100	0.10	690	7.96	*2
LB C2016T1R5M V	1.5	±20%	80	0.15	600	7.96	*2
LB C2016T2R2M V	2.2	±20%	70	0.20	520	7.96	*2
LB C2016T3R3M V	3.3	±20%	55	0.27	410	7.96	*2
LB C2016T4R7M V	4.7	±20%	45	0.37	355	7.96	*2
LB C2016T6R8M V	6.8	±20%	38	0.59	290	7.96	*2
LB C2016T100□ V	10	±10%, ±20%	32	0.82	245	2.52	*2
LB C2016T150∏ V	15	±10%, ±20%	28	1.2	200	2.52	*2
LB C2016T220∏ V	22	±10%, ±20%	16	1.8	165	2.52	*2
LB C2016T330∏ V	33	±10%, ±20%	14	2.8	135	2.52	*2
LB C2016T470∏ V	47	±10%, ±20%	11	4.3	110	2.52	*2
LB C2016T680∐ V	68	±10%, ±20%	10	7.0	95	2.52	*2
LB C2016T101  V	100	±10%, ±20%	8	8.0	75	0.796	*2

<sup>• ☐</sup> Please specify the Inductance tolerance code(K or M)

### ·LB、LBCseries

\*\*) Rated current is determined by the applied current at which the inductance drops 10 % from its initial value or the surface temperature rises to 20 degree C, whichever comes first (at 20°C)

### •LBRseries

XX) Rated current is determined by the applied current at which the inductance drops 20 % from its initial value or the surface temperature rises to 20 degree C, whichever comes first.(at 20°C)

<sup>▶</sup> This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our specification. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our Web site (http://www.ty-top.com/) .

### PART NUMBER 2518(1007)type

Part number	Nominal inductance [ μ H]	Inductance tolerance	Self–resonant frequency [MHz] (min.)	DC Resistance $[\Omega](\pm 30\%)$	Rated current [mA] (max.)	Measuring frequency [MHz]	Note
LB 2518T1R0M V	1.0	±20%	100	0.06	665	7.96	*2
LB 2518T1R5M V	1.5	±20%	80	0.07	405	7.96	*2
LB 2518T2R2M V	2.2	±20%	68	0.09	340	7.96	*2
LB 2518T3R3M V	3.3	±20%	54	0.11	280	7.96	*2
LB 2518T4R7M V	4.7	±20%	46	0.13	240	7.96	*2
LB 2518T4R7MRV	4.7	±20%	46	0.10	235	7.96	*2
LB 2518T6R8M V	6.8	±20%	38	0.15	195	7.96	*2
LB 2518T100[] V	10	±10%, ±20%	30	0.25	165	2.52	*2
LB 2518T150□ V	15	±10%, ±20%	23	0.32	145	2.52	*2
LB 2518T220∏ V	22	±10%, ±20%	19	0.50	115	2.52	*2
LB 2518T330∏ V	33	±10%, ±20%	15	0.70	95	2.52	*2
LB 2518T470∐ V	47	±10%, ±20%	12	0.95	85	2.52	*2
LB 2518T680∐ V	68	±10%, ±20%	9.5	1.5	70	2.52	*2
LB 2518T101 U	100	±10%, ±20%	9.0	2.1	60	0.796	*2
LB 2518T151 0V	150	±10%, ±20%	7.0	3.2	45	0.796	*2
LB 2518T221□ V	220	±10%, ±20%	5.5	4.5	40	0.796	*2
LB 2518T331[] V	330	±10%, ±20%	4.5	7.0	30	0.796	*2
LB 2518T471[] V	470	±10%, ±20%	3.5	10	25	0.796	*2
LB 2518T681 V	680	±10%, ±20%	3.0	17	20	0.796	*2
LB 2518T102[] V	1000	±10%, ±20%	2.4	24	15	0.252	*2

Part number	Nominal inductance [ μ H]	Inductance tolerance	Self-resonant frequency [MHz] (min.)	DC Resistance [Ω](±30%)	Rated current [mA] (max.)	Measuring frequency [MHz]	Note
LB C2518T1R0M V	1.0	±20%	100	0.080	775	7.96	*2
LB C2518T1R0MRV	1.0	±20%	100	0.065	890	7.96	*2
LB C2518T1R5M V	1.5	±20%	80	0.110	730	7.96	*2
LB C2518T2R2M V	2.2	±20%	68	0.130	630	7.96	*2
LB C2518T3R3M V	3.3	±20%	54	0.160	560	7.96	*2
LB C2518T4R7M V	4.7	±20%	41	0.200	510	7.96	*2
LB C2518T6R8M V	6.8	±20%	38	0.300	420	7.96	*2
LB C2518T100□ V	10	±10%, ±20%	30	0.360	375	2.52	*2
LB C2518T150 U	15	±10%, ±20%	23	0.650	285	2.52	*2
LB C2518T220□ V	22	±10%, ±20%	19	0.770	250	2.52	*2
LB C2518T330  V	33	±10%, ±20%	15	1.50	185	2.52	*2
LB C2518T470  V	47	±10%, ±20%	12	1.90	165	2.52	*2
LB C2518T680∏ V	68	±10%, ±20%	9.5	2.80	140	2.52	*2
LB C2518T101  V	100	±10%, ±20%	9.0	3.70	125	0.796	*2
LB C2518T151  V	150	±10%, ±20%	7.0	6.10	95	0.796	*2
LB C2518T221  V	220	±10%, ±20%	5.5	8.40	80	0.796	*2
LB C2518T331□ V	330	±10%, ±20%	4.5	12.3	65	0.796	*2
LB C2518T471  V	470	±10%, ±20%	3.5	22.0	50	0.796	*2
LB C2518T681[] V	680	±10%, ±20%	3.0	28.0	45	0.796	*2

Part number	Nominal inductance	Inductance tolerance	Self-resonant frequency [MHz] (min.)	DC Resistance [Ω](±30%)	Rated current [mA] (max.)	Measuring frequency [MHz]	Note
LB R2518T1R0M V	1.0	±20%	100	0.045	960	7.96	*2
LB R2518T2R2M V	2.2	±20%	68	0.07	480	7.96	*2
LB R2518T4R7M V	4.7	±20%	45	0.10	345	7.96	*2
LB R2518T100[] V	10	±10%, ±20%	30	0.19	235	2.52	*2
LB R2518T220□ V	22	±10%, ±20%	19	0.44	175	2.52	*2
LB R2518T470□ V	47	±10%, ±20%	11	0.84	120	2.52	*2
LB R2518T101∏ V	100	±10%, ±20%	9	1.89	80	0.796	*2

### **3218(1207)** type

3218(1207)type							
Part number	Nominal inductance [ μ H]	Inductance tolerance	Self-resonant frequency [MHz] (min.)	DC Resistance $[\Omega](\pm 30\%)$	Rated current [mA] (max.)	Measuring frequency [MHz]	Note
LB 3218T1R0M V	1.0	±20%	100	0.06	1,075	7.96	*2
LB 3218T1R5M V	1.5	±20%	80	0.07	860	7.96	*2
LB 3218T2R2M V	2.2	±20%	68	0.09	775	7.96	*2
LB 3218T3R3M V	3.3	±20%	54	0.11	560	7.96	*2
LB 3218T4R7M V	4.7	±20%	41	0.13	550	7.96	*2
LB 3218T6R8M V	6.8	±20%	40	0.17	380	7.96	*2
LB 3218T100□ V	10	±10%, ±20%	30	0.25	340	2.52	*2
LB 3218T150 V	15	±10%, ±20%	25	0.32	300	2.52	*2
LB 3218T220□ V	22	±10%, ±20%	19	0.49	255	2.52	*2
LB 3218T330□ V	33	±10%, ±20%	15	0.75	215	2.52	*2
LB 3218T470[] V	47	±10%, ±20%	12	0.92	205	2.52	*2
LB 3218T680□ V	68	±10%, ±20%	11	1.49	145	2.52	*2
LB 3218T101□ V	100	±10%, ±20%	8.0	2.4	140	0.796	*2
LB 3218T151 V	150	±10%, ±20%	7.0	3.2	105	0.796	*2
LB 3218T221[] V	220	±10%, ±20%	5.0	5.4	80	0.796	*2
LB 3218T331[] V	330	±10%, ±20%	4.0	7.0	65	0.796	*2
LB 3218T471[] V	470	±10%, ±20%	3.5	14	54	0.796	*2
LB 3218T681[] V	680	±10%, ±20%	3.0	17	45	0.796	*2
LB 3218T102[] V	1000	±10%, ±20%	2.4	27	39	0.252	*2

<sup>• []</sup> Please specify the Inductance tolerance code (K or M)

XX) Rated current is determined by the applied current at which the inductance drops 10 % from its initial value or the surface temperature rises to 20 degree C, whichever comes first.(at 20°C)

### •LBRserie

XX)Rated current is determined by the applied current at which the inductance drops 20 % from its initial value or the surface temperature rises to 20 degree C, whichever comes first.(at 20°C)

<sup>•</sup>LB、LBCseries

<sup>▶</sup> This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our specification. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our Web site (http://www.ty-top.com/) .

### PART NUMBER

Part number	Nominal inductance [ μ Η]	Inductance tolerance	Self-resonant frequency [MHz] (min.)	DC Resistance [Ω](±30%)	Rated current [mA] (max.)	Measuring frequency [MHz]	Note
LB C3225T1R0MRV	1.0	±20%	250	0.055	1,100	0.1	*2
LB C3225T1R5MRV	1.5	±20%	220	0.060	1,000	0.1	*2
LB C3225T2R2MRV	2.2	±20%	190	0.080	930	0.1	*2
LB C3225T3R3MRV	3.3	±20%	160	0.095	850	0.1	*2
LB C3225T4R7MRV	4.7	±20%	70	0.100	830	0.1	*2
LB C3225T6R8MRV	6.8	±20%	50	0.120	760	0.1	*2
LB C3225T100[]RV	10	±10%, ±20%	23	0.133	720	0.1	*2
LB C3225T150[RV	15	±10%, ±20%	20	0.195	590	0.1	*2
LB C3225T220[]RV	22	±10%, ±20%	17	0.27	500	0.1	*2
LB C3225T330[]RV	33	±10%, ±20%	13	0.41	400	0.1	*2
LB C3225T470□RV	47	±10%, ±20%	10	0.67	320	0.1	*2
LB C3225T680□RV	68	±10%, ±20%	8	1.0	260	0.1	*2
LB C3225T101 RV	100	±10%, ±20%	6	1.4	220	0.1	*2

<sup>• 
☐</sup> Please specify the Inductance tolerance code(K or M)

### ·LB、LBCseries

XX) Rated current is determined by the applied current at which the inductance drops 10 % from its initial value or the surface temperature rises to 20 degree C, whichever comes first.(at 20°C)

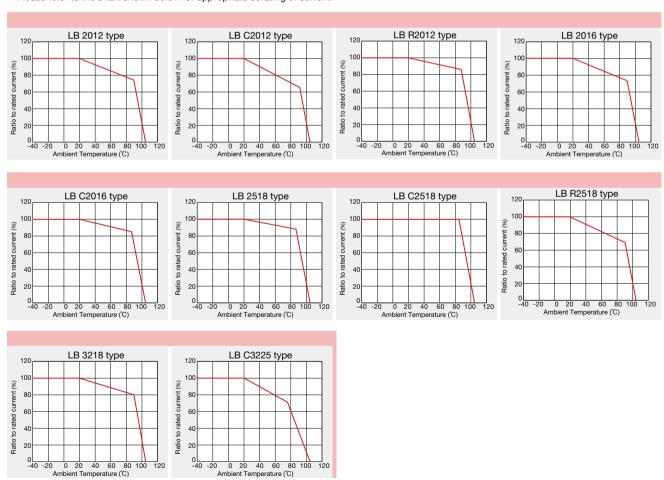
#### ·LBRseries

XX) Rated current is determined by the applied current at which the inductance drops 20 % from its initial value or the surface temperature rises to 20 degree C, whichever comes first.(at 20°C)

### Derating of Rated Current

### LB series

Delating of current is necessary for LB series depending on ambient temperature. Please refer to the chart shown below for appropriate derating of current.



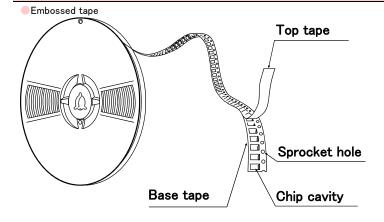
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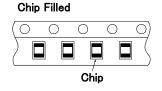
## WIRE-WOUND CHIP INDUCTORS (LB SERIES), WIRE-WOUND CHIP POWER INDUCTORS (CB SERIES), WIRE-WOUND CHIP INDUCTORS FOR SIGNAL LINES (LB SERIES M TYPE)

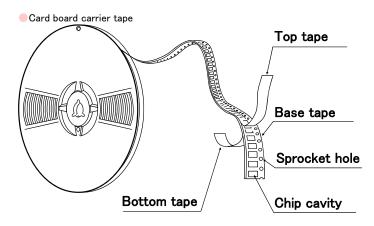
### PACKAGING

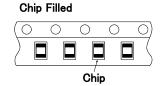
#### 1 Minimum Quantity Standard Quantity [pcs] Туре Paper Tape Embossed Tape LB C3225 1000 CB C3225 LB 3218 2000 LB R2518 LB C2518 2000 LB 2518 CB 2518 CB C2518 LBM2016 LB C2016 LB 2016 2000 CB 2016 CB C2016 LB 2012 LB C2012 LB R2012 3000 CB 2012 CB C2012 CB L2012 4000 LB 1608 4000 LBMF1608 3000 CBMF1608

### ②Tape material



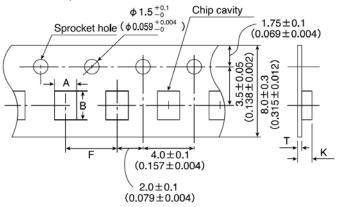






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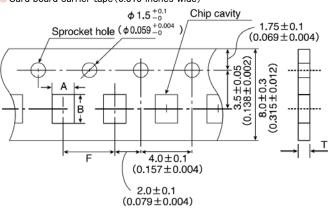
### Embossed Tape (0.315 inches wide)



Т	Chip	cavity	Insertion pitch	Tape th	ickness
Туре	Α	В	F	Т	K
LBM2016	1.75±0.1	2.1±0.1	4.0±0.1	0.3±0.05	1.9max.
	(0.069±0.004)	(0.083±0.004)	(0.157±0.004)	(0.012±0.002)	(0.075max.)
LB C3225	2.8±0.1	3.5±0.1	4.0±0.1	0.3±0.05	4.0max.
CB C3225	(0.110±0.004)	(0.138±0.004)	(0.157±0.004)	(0.012±0.002)	(0.157max.)
LB 3218	2.1±0.1	3.5±0.1	4.0±0.1	0.3±0.05	2.2max.
	(0.083±0.004)	(0.138±0.004)	(0.157±0.004)	(0.012±0.002)	(0.087max.)
LB 2518 CB 2518 LB C2518 CB C2518 LB R2518	2.15±0.1	2.7±0.1	4.0±0.1	0.3±0.05	2.2max.
	(0.085±0.004)	(0.106±0.004)	(0.157±0.004)	(0.012±0.002)	(0.087max.)
LB 2016 CB 2016 LB C2016 CB C2016	1.75±0.1 (0.069±0.004)	2.1±0.1 (0.083±0.004)	4.0±0.1 (0.157±0.004)	0.3±0.05 (0.012±0.002)	1.9max. (0.075max.)
LB 2012 CB 2012 LB C2012 CB C2012 LB R2012	1.45±0.1 (0.057±0.004)	2.25±0.1 (0.089±0.004)	4.0±0.1 (0.157±0.004)	0.25±0.05 (0.010±0.002)	1.45max. (0.057max.)
LBMF1608	1.1±0.1	1.9±0.1	4.0±0.1	0.25±0.05	1.2max.
CBMF1608	(0.043±0.004)	(0.075±0.004)	(0.157±0.004)	(0.010±0.002)	(0.047max.)

Unit:mm(inch)

### Card board carrier tape (0.315 inches wide)

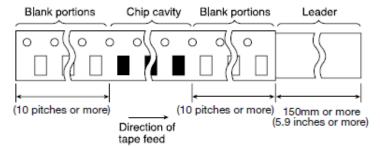


T	Chip	cavity	Insertion pitch	Tape thickness
Туре	Α	В	F	Т
CB L2012	1.55±0.1	2.3±0.1	4.0±0.1	1.1max.
	$(0.061 \pm 0.004)$	$(0.091 \pm 0.004)$	$(0.157 \pm 0.004)$	(0.043max.)
LB 1608	1.0±0.1	1.8±0.1	4.0±0.1	1.1max.
LB 1608	$(0.039 \pm 0.004)$	$(0.071 \pm 0.004)$	$(0.157 \pm 0.004)$	(0.043max.)

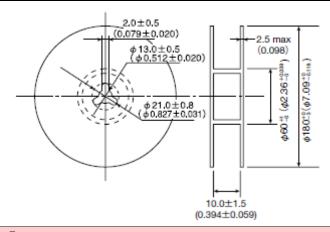
Unit:mm(inch)

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### 4 Leader and Blank Portion



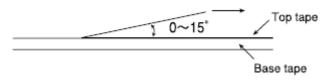
### ⑤Reel Size



### **©**Top Tape Strength

The top tape requires a peel-off force 0.2 to 0.7N in the direction of the arrow as illustrated below.

### Pull direction



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## WIRE-WOUND CHIP INDUCTORS (LB SERIES), WIRE-WOUND CHIP POWER INDUCTORS (CB SERIES), WIRE-WOUND CHIP INDUCTORS FOR SIGNAL LINES (LB SERIES M TYPE)

### ■ RELIABILITY DATA

ture Range						
LB, LBC, LBR Series						
CB, CBC Series	-40∼+105°C(Including self-generated heat)					
LBM Series						
Including self-generated heat						
LB, LBC, LBR Series						
CB, CBC Series	_40~+85°C					
LBM Series						
Please refer the term of "7. storage conditions" in precautions.						
	T					
CB, CBC Series	Within the specified tolerance					
LBM Series						
LB, LBC, LBR Series						
CB, CBC Series	Within the specified tolerance					
LBM Series						
Test Methods and LB·LBC·LBR·CB·CBC·LBM Series						
Measuring equipment :LCR Mater(HP4285A or its e	quivalent)					
LB, LBC, LBR Series						
CB, CBC Series						
LBM Series	Within the specified tolerance					
LBM Series						
Measuring equipment : LCR Mater(HP4285A or its eq	uivalent)					
LB, LBC, LBR Series						
CB, CBC Series	Within the specified tolerance					
LBM Series						
Measuring equipment : DC Ohmmeter (HIOKI 3227 or its equ	ivalent)					
Millanov						
· ·						
	Within the appaired tolerance					
	Within the specified tolerance					
	LBM Series  Measuring equipment : Impedance analyzer (HP4291A or its equivalent)					
	LB, LBC, LBR Series  CB, CBC Series  LBM Series  Including self-generated heat  ture Range (after soldering)  LB, LBC, LBR Series  CB, CBC Series  LBM Series  LB, CB Series: Please refer the term of "7. storage conditions" in precaution  LB, LBC, LBR Series  CB, CBC Series  LBM Series  LB, LBC, LBR Series  CB, CBC Series  LBM Series  LB, LBC, LBR Series  CB, CBC Series  LBM Series  LB-LBC-LBR-CB-CBC-LBM Series  Measuring equipment : LCR Mater (HP4285A or its equipment): LCR Mater (HIOKI 3227 or its equipment): LCR Mater (HIO					

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0.T Ob					
8.Temperature Char	ı				
	LBM2016				Inductance change : Within±10%
	LB2012	LBR2012	CB2012	LB2016	
	CB2016	LB2518	LBR2518	CB2518	Inductance change : Within±20%
Specified Value	LBC3225	CBC3225			
	LBC2016	CBC2016	LBC2518	CBC2518	T. I
	LB3218				Inductance change : Within±25%
	LBC2012	CBC2012			Inductance change : Within±35%
	Change of	maximum inductar	nce deviation in	step 1-5	•
	C.	Temperature (°C)			
	Step	LB, CB Serie			
Test Methods and	1		20		
Remarks	2		-40		
	3	20(Reference temperature)		e)	
	4	+85 (Maximum operating temperature)		rature)	
	5		20	•	

9.Rasistance to Fle	xure of Substrate	
	LB, LBC, LBR Series	No damage.
Specified Value	CB, CBC Series	
	LBM Series	
Test Methods and Remarks	Warp : 2mm(LB·LBC·LBR·CB·CBC·LBM Series)  Test substrate : Board according to JIS C0051  Thickness : 1.0mm  Pressing jig  10 20  R340  Board  A5±2mm  A5±2mm	

10.Body Strength		
Specified Value	LB, LBC, LBR Series	No damage.
	CB, CBC Series	
	LBM Series	
Test Methods and Remarks	LB·LBC·LBR·CB·CBC·LBM Applied force : 10N Duration : 10sec.	

11.Adhesion of term	ninal electrode			
	LB, LBC, LBR Series			
Specified Value	CB, CBC Series		No abnormality.	No abnormality.
	LBM Series			
Test Methods and Remarks	LB · LBC · LBR · CB Applied force Duration Test substrate	•CBC•CBL•LBM : 10N to X and Y directions 5 sec. : Printed board		

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12.Resistance to vil	bration					
	LB, LBC, LBR Series		Inductance change : Within±20%			
Specified Value	CB, CBC Series		No significant abnormality in appearance.			
	LBM Series		Inductance change : Within±20%  No significant abnormality in appearance.			
	LB·LBR·LBC·CB·CBC·LBM : According to JIS C5102 clause 8.2.					
Test Methods and Remarks	Vibration type Directions Frequency range Amplitude Mounting method Recovery	: A : 2 hrs each in X, Y and Z direction : 10 to 55 to 10 Hz (1min.) : 1.5mm : Soldering onto printed board : At least 2 hrs of recovery under thrs.	ns. Total:6 hrs the standard condition after the test, followed by the measurement within 48			
13.Drop test	T					
	LB, LBC, LBR Series					
Specified Value	CB, CBC Series					
	LBM Series					
14.Solderability						
· · · · · · · · · · · · · · · · · · ·	LB. LBC. LBR Series					
Specified Value	CB. CBC Series		At least 90% of surface of terminal electrode is covered by new			
Spoomed Value	LBM Series					
	LB·LBC·LBR·CB·CB	C.CRI.IRM				
Test Methods and	Solder temperature	: 245±5°C				
Remarks	Duration	: 5±0.5sec				
	Flux	: Methanol solution with 25% of c	olophony			
15.Resistance to so	oldering					
	LB, LBC, LBR Series		Inductance change : Within±20%			
Specified Value	CB, CBC Series					
	LBM Series		Inductance change : Within±20%			
Test Methods and Remarks	LB·LBC·LBR·CB·CB 3 times of reflow over	C·CBL·LBM: n at 230°C MIN for 40sec. with peak	temperature at 260 °C for 5sec.			
16.Resisitance to s	olvent					
10.1103/3/100/100/100/3/	LB, LBC, LBR Series					
Specified Value	CB, CBC Series					
specified value	LBM Series		_			
		. D				
Test Methods and Remarks	Solvent temperature Type of solvent	: Room temperature : Isopropyl alcohol				
	Cleaning conditions	: 90s. Immersion and cleaning.				
17.TI III						
17.Thermal shock	ID IDO IDD C					
	LB, LBC, LBR Series		Inductance change : Within±20%			
Specified Value	CB, CBC Series		No significant abnormality in appearance.			
	LBM Series					
Tarak Makharaha awal						
Test Methods and Remarks			standard condition after the test, followed by the measurement within 48 hrs.			

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Specified Value   Specified						
Case	18.Damp heat life to	est				
CBU US-Series   No significant abnormality in appearance.		LB, LBC, LBR Series				
LBM Series   Security   Temperature   30±2°C	Specified Value	CB, CBC Series	_			
Test Methods and Name 1		LBM Series	No Significant abnormality in appearance.			
Burstion   1000 hrs		Temperature : 60±2°C				
Recovery   At least 2 hrs of recovery under the standard condition after the test, followed by the measurement within 48 hrs.    Specified Value   LB, LBC, LBR Series   Inductance change : Within ± 20%   No significant abnormality in appearance.	Test Methods and	Humidity : 90∼95%RH				
Specified Value   LB LBC LBR Series   Inductance change : Within ± 20%	Remarks					
LB LBC LBR Series		Recovery : At least 2 hrs of recovery under the s	standard condition after the test, followed by the measurement within 48 hrs.			
LB LBC LBR Series						
CBC CBC Series   LBM Series   Series   Inductance change : Within ±20%   No significant abnormality in appearance.	19.Loading under da					
LBM Series		LB, LBC, LBR Series	Industance change: Within + 2004			
LBM Series	Specified Value	CB, CBC Series				
Test Methods and Remarks   Specified Value   LBL BC LBR Series   LBL CBC Series   LBL CBC LBR		LBM Series				
Test Methods and Remarks		•				
Applied current : Rated current Recovery : At least 2 hrs of recovery under the standard condition after the test, followed by the measurement within 48 hrs.  20 High temperature life test    I.B. LBC, LBR Series	Test Methods and					
Recovery	Remarks					
20.High temperature   life test			standard condition after the test, followed by the measurement within 48 hrs.			
LB, LBC, LBR Series		· · · · · · · · · · · · · · · · · · ·				
LB, LBC, LBR Series	20 High temperature	e life test				
Specified Value   CB, CBC Series   Inductance change: Within±20%   No significant abnormality in appearance.			T_			
LBM Series  LBM Series  Test Methods and Remarks  Temperature	Specified Value		T. I			
Test Methods and Remarks  Temperature : 85±2°C Duration : 1000 hrs Recovery : At least 2 hrs of recovery under the standard condition after the test, followed by the measurement within 48 hrs.  21.Loading at high temperature life test  LB, LBC, LBR Series   Inductance change : Within±2096 No significant abnormality in appearance.  CB, CBC Series   Inductance change : Within±2096 No significant abnormality in appearance.  Test Methods and Remarks   Temperature : 85±2°C Duration : 1000 hrs Applied current : Rated current Recovery : At least 2 hrs of recovery under the standard condition after the test, followed by the measurement within 48 hrs.  22.Low temperature life test  LB, LBC, LBR Series   Inductance change : Within±2096 No significant abnormality in appearance.  LBM Series   Inductance change : Within±2096 No significant abnormality in appearance.  Test Methods and Remarks   Temperature : -40±2°C Duration : 1000 hrs Recovery : At least 2 hrs of recovery under the standard condition after the test, followed by the measurement within 48 hrs.  23.Standard condition  LB, LBC, LBR Series   Standard test conditions Unless specified, Ambient temperature is 20±15°C and the Relative humidity is 65±2096. If there is any doubt about the test results, further measurement shall be had within the following limits: Ambient Temperature: 20±2°C Relative humidity: 65±396	opecinieu value	<u>'</u>	<del></del>			
Test Methods and Remarks    Duration Recovery   Specified Value   CB, CBC Series   LB, LBC, LBR Series   Second Se	-		The digilillocate abnormality in appearance.			
Recovery   At least 2 hrs of recovery under the standard condition after the test, followed by the measurement within 48 hrs.    21.Loading at high temperature life test	Test Methods and	•				
LB, LBC, LBR Series	Remarks					
LB, LBC, LBR Series						
LB, LBC, LBR Series   No significant abnormality in appearance.	21.Loading at high t	emperature life test				
Specified Value  CB, CBC Series  LBM Series  Temperature : 85±2°C  Duration : 1000 hrs  Applied current : Rated current  Recovery : At least 2 hrs of recovery under the standard condition after the test, followed by the measurement within 48 hrs.  22.Low temperature life test  CB, CBC Series  LBM Series  Test Methods and Remarks  Test Methods and Remarks  Diagrature : -40±2°C Duration : 1000 hrs Recovery : At least 2 hrs of recovery under the standard condition after the test, followed by the measurement within 48 hrs.  23.Standard condition  LB, LBC, LBR Series  LBM Series  LBM Series  LBM Series  Standard test conditions  Unless specified, Ambient temperature is 20±15°C and the Relative humidity is 65±20%. If there is any doubt about the test results, further measurement shall be had within the following limits: Ambient Temperature: 20±2°C Relative humidity: 65±5%		10.100.100.1	Inductance change : Within±20%			
Test Methods and Remarks    Duration		LB, LBC, LBR Series	No significant abnormality in appearance.			
Test Methods and Remarks    Temperature	Specified Value	CB, CBC Series				
Test Methods and Remarks    Duration		LBM Series				
Remarks Applied current Recovery : At least 2 hrs of recovery under the standard condition after the test, followed by the measurement within 48 hrs.  22.Low temperature life test  LB, LBC, LBR Series  CB, CBC Series  LBM Series  Test Methods and Remarks  Temperature : -40±2°C Duration : 1000 hrs Recovery : At least 2 hrs of recovery under the standard condition after the test, followed by the measurement within 48 hrs.  23.Standard condition  LB, LBC, LBR Series  CB, CBC Series  LBM Series  L	-	Temperature : 85±2°C				
Recovery : At least 2 hrs of recovery under the standard condition after the test, followed by the measurement within 48 hrs.  22.Low temperature life test    LB, LBC, LBR Series	Test Methods and					
22.Low temperature life test  Specified Value    LB, LBC, LBR Series	Remarks					
LB, LBC, LBR Series   Inductance change : Within±20%   No significant abnormality in appearance.		Recovery : At least 2 hrs of recovery under the s	standard condition after the test, followed by the measurement within 48 hrs.			
LB, LBC, LBR Series   Inductance change : Within±20%   No significant abnormality in appearance.						
Specified Value  CB, CBC Series  LBM Series  Test Methods and Remarks  Temperature : -40±2°C Duration : 1000 hrs Recovery : At least 2 hrs of recovery under the standard condition after the test, followed by the measurement within 48 hrs.  23.Standard condition  LB, LBC, LBR Series  CB, CBC Series  LBM Series  LBM Series  LBM Series  Inductance change : Within±20% No significant abnormality in appearance.  Standard condition after the test, followed by the measurement within 48 hrs.  Standard test conditions Unless specified, Ambient temperature is 20±15°C and the Relative humidity is 65±20%. If there is any doubt about the test results, further measurement shall be had within the following limits: Ambient Temperature: 20±2°C Relative humidity: 65±5%	22.Low temperature					
Test Methods and Remarks  Temperature : -40±2°C Duration : 1000 hrs Recovery : At least 2 hrs of recovery under the standard condition after the test, followed by the measurement within 48 hrs.  23.Standard condition  LB, LBC, LBR Series  CB, CBC Series  Standard test conditions  Unless specified, Ambient temperature is 20±15°C and the Relative humidity is 65±20%. If there is any doubt about the test results, further measurement shall be had within the following limits:  Ambient Temperature: 20±2°C Relative humidity: 65±5%		LB, LBC, LBR Series	Inductance change: Within + 20%			
Test Methods and Remarks  Temperature	Specified Value	CB, CBC Series				
Duration Remarks   Duration Recovery   1000 hrs		LBM Series				
Remarks    Duration	Test Methods and	•				
23.Standard condition  LB, LBC, LBR Series  CB, CBC Series  Specified Value  LBM Series  LBM Series  Standard test conditions Unless specified, Ambient temperature is 20±15°C and the Relative humidity is 65±20%. If there is any doubt about the test results, further measurement shall be had within the following limits: Ambient Temperature: 20±2°C Relative humidity: 65±5%						
LB, LBC, LBR Series  CB, CBC Series  Unless specified, Ambient temperature is 20±15°C and the Relative humidity is 65±20%. If there is any doubt about the test results, further measurement shall be had within the following limits:  Ambient Temperature: 20±2°C Relative humidity: 65±5%	-	. At least 2 in 3 or recovery under the standard condition after the test, followed by the measurement within 40 lifs.				
LB, LBC, LBR Series  CB, CBC Series  Unless specified, Ambient temperature is 20±15°C and the Relative humidity is 65±20%. If there is any doubt about the test results, further measurement shall be had within the following limits:  Ambient Temperature: 20±2°C Relative humidity: 65±5%						
CB, CBC Series  Unless specified, Ambient temperature is 20±15°C and the Relative humidity is 65±20%. If there is any doubt about the test results, further measurement shall be had within the following limits:  Ambient Temperature: 20±2°C Relative humidity: 65±5%	23.Standard condition	on				
Specified Value  LBM Series  humidity is 65±20%. If there is any doubt about the test results, further measurement shall be had within the following limits:  Ambient Temperature: 20±2°C Relative humidity: 65±5%		LB, LBC, LBR Series	Unless specified, Ambient temperature is 20±15°C and the Relative			
Specified Value  LBM Series  measurement shall be had within the following limits:  Ambient Temperature: 20±2°C  Relative humidity: 65±5%		CB, CBC Series				
LBM Series  Ambient Temperature: 20±2°C Relative humidity: 65±5%	Specified Value					
Relative humidity: 65±5%	1	LBM Series				
Inductance value is based on our standard measurement systems.						
			Inductance value is based on our standard measurement systems.			

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## WIRE-WOUND CHIP INDUCTORS (LB SERIES), WIRE-WOUND CHIP POWER INDUCTORS (CB SERIES), WIRE-WOUND CHIP INDUCTORS FOR SIGNAL LINES (LB SERIES M TYPE)

### ■ PRECAUTIONS

### 1. Circuit Design 1. All electronic components listed in this catalogue are intended for use in general electronic equipment such as AV/OA equipment, home electrical appliances, office equipment, information-communication equipment, general medical equipment, industrial equipment. and automotive applications Precautions Please be sure to contact TAIYO YUDEN CO., LTD. for further information before using the components for any equipment which might have a negative impact directly on human life, such as specially controlled medical equipment, transportation equipment (automotive powertrain/train/ship control systems, etc.) and traffic signal system. Please do not incorporate the components into any equipment requiring a high degree of safety and reliability, such as aerospace equipment, avionics, nuclear control equipment, submarine system, and military equipment 2. PCB Design ◆Land pattern design Precautions 1. Please contact any of our offices for a land pattern, and refer to a recommended land pattern of a right figure or specifications. [Recommended Land Patterns] Technical Surface Mounting considerations Mounting and soldering conditions should be checked beforehand. · Applicable soldering process to those products is reflow soldering only. 3. Considerations for automatic placement ◆Adjustment of mounting machine Precautions 1. Excessive impact load should not be imposed on the products when mounting onto the PC boards. 2. Mounting and soldering conditions should be checked beforehand. Technical 1. When installing products, care should be taken not to apply distortion stress as it may deform the products. considerations 4. Soldering



◆Reflow soldering( LB and CB Types)

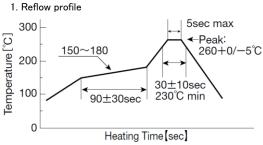
◆Reflow soldering( LB and CB Types)

### Precautions

- 1. For reflow soldering with either leaded or lead-free solder, the profile specified in "point for controlling" is recommended.
- igspaceRecommended conditions for using a soldering iron
  - 1. Put the soldering iron on the land-pattern. Soldering iron's temperature Below 350°C Duration-3 seconds or less. The soldering iron should not come in contact with inductor directly.

### 30

### Technical considerations



- Recommended conditions for using a soldering iron
- 1. Components can be damaged by excessive heat where soldering conditions exceed the specified range.

# Precautions Cleaning conditions Washing by supersonic waves shall be avoided. Technical considerations Technical tonsiderations Technical considerations Technical tonsiderations Technical tonsi

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6. Handling	
Precautions	<ul> <li>◆Handling</li> <li>1. Keep the inductors away from all magnets and magnetic objects.</li> <li>◆Breakaway PC boards (splitting along perforations)</li> <li>1. When splitting the PC board after mounting inductors, care should be taken not to give any stresses of deflection or twisting to the board.</li> <li>2. Board separation should not be done manually, but by using the appropriate devices.</li> <li>◆Mechanical considerations</li> <li>1. Please do not give the inductors any excessive mechanical shocks.</li> </ul>
Technical considerations	<ul> <li>◆Handling</li> <li>1. There is a case that a characteristic varies with magnetic influence.</li> <li>◆Breakaway PC boards( splitting along perforations)</li> <li>1. Planning pattern configurations and the position of products should be carefully performed to minimize stress.</li> <li>◆Mechanical considerations</li> <li>1. There is a case to be damaged by a mechanical shock.</li> </ul>

	♦Storage
	1. To maintain the solderability of terminal electrodes and to keep the packing material in good condition, temperature and humidity in the
	storage area should be controlled.
Precautions	Recommended conditions
	Ambient temperature:0~40°C / Humidity:Below 70% RH
	The ambient temperature must be kept below 30°C even under ideal storage conditions, solderability of products electrodes may
	decrease as time passes. For this reason, These series should be used within 6 months from the time of delivery.
Technical	♦Storage
considerations	1. Under a high temperature and humidity environment, problems such as reduced solderability caused by oxidation of terminal electrodes
Considerations	and deterioration of taping/packaging materials may take place.